

NCV8876

Automotive Grade Start-Stop Non-Synchronous Boost Controller

The NCV8876 is a Non-Synchronous Boost controller designed to supply a minimum output voltage during Start-Stop vehicle operation battery voltage sags. The controller drives an external N-channel MOSFET. The device uses peak current mode control with internal slope compensation. The IC incorporates an internal regulator that supplies charge to the gate driver.

Protection features include, cycle-by-cycle current limiting, protection and thermal shutdown.

Additional features include low quiescent current sleep mode operation. The NCV8876 is enabled when the supply voltage drops below 7.3 V, with boost operation initiated when the supply voltage is below 6.8 V.

Features

- Automatic Enable Below 7.3 V (Factory Programmable)
- Boost Mode Operation at 6.8 V
- $\pm 2\%$ Output Accuracy Over Temperature Range
- Peak Current Mode Control with Internal Slope Compensation
- Externally Adjustable Frequency Operation
- Wide Input Voltage Range of 2 V to 40 V, 45 V Load Dump
- Low Quiescent Current in Sleep Mode ($<11 \mu\text{A}$ Typical)
- Cycle-by-Cycle Current Limit Protection
- Hiccup-Mode Overcurrent Protection (OCP)
- Thermal Shutdown (TSD)
- This is a Pb-Free Device

Typical Applications

- Applications Requiring Regulated Voltage through Cranking and Start-Stop Operation



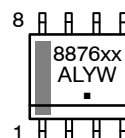
ON Semiconductor®

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MARKING DIAGRAM



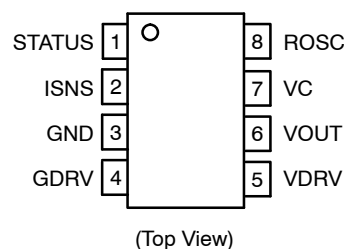
SOIC-8
D SUFFIX
CASE 751



8876xx = Specific Device Code
xx = 00, 01

A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

PIN CONNECTIONS



(Top View)

ORDERING INFORMATION

Device	Package	Shipping†
NCV887600D1R2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel
NCV887601D1R2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

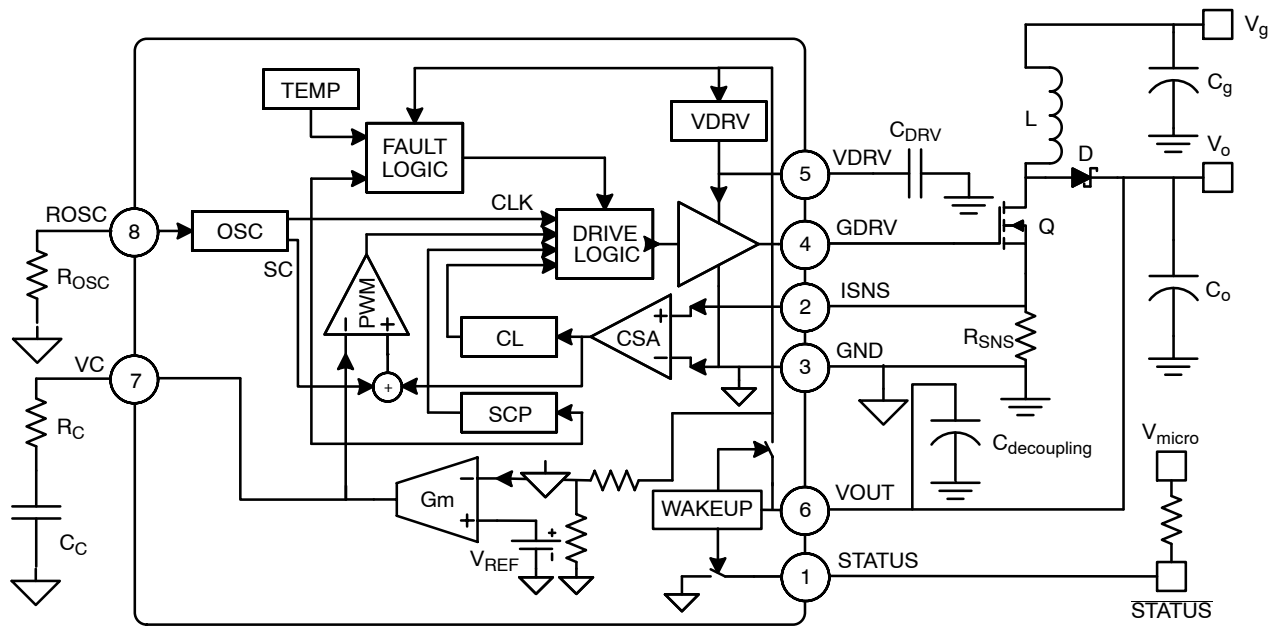


Figure 1. Typical Application

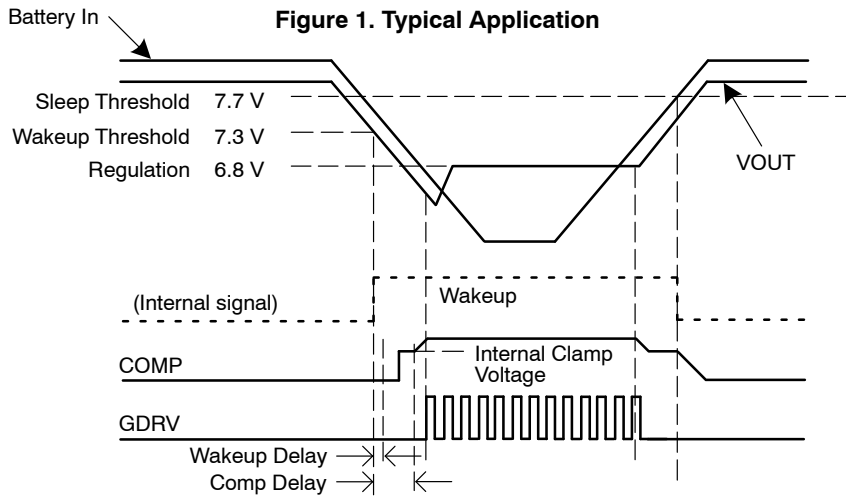


Figure 2. Functional Waveforms

PACKAGE PIN DESCRIPTIONS

Pin No.	Pin Symbol	Function
1	STATUS	This is an open-drain diagnostic. IC status operation flag indicator. This output is a logic low when IC VOUT is below 7.3 V and device is active. A pull-up resistor of around 80 k Ω should be connected between STATUS and a microcontroller reference. This output is a logic high when the IC is disabled or in UVLO. Ground is left unused.
2	ISNS	Current sense input. Connect this pin to the source of the external N-MOSFET, through a current-sense resistor to ground to sense the switching current for regulation and current limiting.
3	GND	Ground reference.
4	GDRV	Gate driver output. Connect to gate of the external N-MOSFET. A series resistance can be added from GDRV to the gate to tailor EMC performance.
5	VDRV	Driving voltage. Internally-regulated supply for driving the external N-MOSFET, sourced from VOUT. Bypass with a 1.0 μ F ceramic capacitor to ground.
6	VOUT	Monitors output voltage and provides IC input voltage.
7	VC	Output of the voltage error transconductance amplifier. An external compensator network from VC to GND is used to stabilize the converter.
8	ROSC	Use a resistor to ground to set the frequency.

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ABSOLUTE MAXIMUM RATINGS (Voltages are with respect to GND, unless otherwise indicated)

Rating	Value	Unit
Dc Supply Voltage (VOUT)	–0.3 to 40	V
Peak Transient Voltage (Load Dump on VOUT)	45	V
Dc Supply Voltage (VDRV, GDRV)	12	V
Dc Voltage (VC, ISNS, ROSC)	–0.3 to 3.6	V
Dc Voltage (STATUS)	–0.3 to 6	V
Dc Voltage Stress (VOUT – VDRV)	–0.7 to 40	V
Operating Junction Temperature	–40 to 150	°C
Storage Temperature Range	–65 to 150	°C
Peak Reflow Soldering Temperature: Pb–Free, 60 to 150 seconds at 217°C	265 peak	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

PACKAGE CAPABILITIES

Characteristic	Value	Unit	
ESD Capability (All Pins)	Human Body Model Machine Model	≥2.0 ≥200	kV V
Moisture Sensitivity Level		1	
Package Thermal Resistance	Junction-to-Ambient, R _{θJA} (Note 1)	100	°C/W

1. 1 in², 1 oz copper area used for heatsinking.

TYPICAL VALUES

Part No.	D _{max}	f _S	S _a	V _{cl}	I _{src}	I _{sink}	VOUT	SCE
NCV887600	83%	170 kHz	34 mV/μs	400 mV	800 mA	600 mA	6.8 V	N
NCV887601	83%	170 kHz	53 mV/μs	200 mV	800 mA	600 mA	6.8 V	N

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ELECTRICAL CHARACTERISTICS ($-40^{\circ}\text{C} < T_J < 150^{\circ}\text{C}$, $3.6\text{ V} < V_{\text{OUT}} < 40\text{ V}$, unless otherwise specified) Min/Max values are guaranteed by test, design or statistical correlation.

Characteristic	Symbol	Conditions	Min	Typ	Max	Unit
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GENERAL

Quiescent Current, Sleep Mode	$I_{q,\text{sleep}}$	$V_{\text{OUT}} = 13.2\text{ V}$, $T_J = 25^{\circ}\text{C}$	–	12	14	μA
Quiescent Current, No switching	$I_{q,\text{off}}$	Into V_{OUT} pin, $6.8\text{ V} < V_{\text{OUT}} < 7.3\text{ V}$, No switching	–	2.2	4.0	mA

OSCILLATOR

Switching Frequency	F_{SW}	Operating Range NCV887600 NCV887601	153 153	– –	501 501	kHz
R_{OSC} Voltage	V_{ROSC}		–	1.0	–	V
Default Switching	F_{SW}	ROSC = Open (NCV887600, NCV887601) ROSC = $100\text{ k}\Omega$ ROSC = $20\text{ k}\Omega$ ROSC = $10\text{ k}\Omega$	153 180 283 409	170 200 315 455	187 220 347 501	kHz
Minimum Pulse Width	$t_{\text{on,min}}$		90	115	140	ns
Maximum Duty Cycle	D_{max}	ROSC = OPEN	81	83	85	%
Slope Compensating Ramp (Note 2)	S_a	NCV887600 NCV887601	30 46	34 53	38 60	$\text{mV}/\mu\text{s}$

STATUS FLAG

STATUS Wake Up Delay		$V_{\text{OUT}} < 7.3\text{ V}$	–	9.3	14.0	μs
STATUS Pull-down Capability		Sinking 1.0 mA	–	–	400	mV

CURRENT SENSE AMPLIFIER

Low-Frequency Gain	A_{CSA}	Input-to-output gain at dc, $I_{\text{SNS}} \leq 1\text{ V}$	0.9	1.0	1.1	V/V
Bandwidth	BW_{CSA}	Gain of $A_{\text{CSA}} - 3\text{ dB}$	2.5	–	–	MHz
ISNS Input Bias Current	$I_{\text{SNS,bias}}$	Out of ISNS pin	–	30	50	μA
Current Limit Threshold Voltage	V_{CL}	Voltage on ISNS pin NCV887600 NCV887601	360 180	400 200	440 220	mV
Current Limit, Response Time (Note 2)	t_{CL}	CL tripped until GDRV falling edge, $V_{\text{ISNS}} = V_{\text{CL}}(\text{typ}) + 60\text{ mV}$	–	80	125	ns
Overcurrent Protection, Threshold Voltage	$\%V_{\text{OCP}}$	Percent of V_{CL}	125	150	175	%
Overcurrent Protection, Response Time (Note 2)	t_{OCP}	From overcurrent event, Until switching stops, $V_{\text{ISNS}} = V_{\text{OCP}} + 40\text{ mV}$	–	80	125	ns

VOLTAGE ERROR OPERATIONAL TRANSCONDUCTANCE AMPLIFIER

Transconductance	$g_{\text{m,vea}}$	$V_{\text{OUT}} = \pm 100\text{ mV}$	0.8	1.2	1.6	mS
VEA Output Resistance (Note 2)	$R_{\text{o,vea}}$		2.0	–	–	$\text{M}\Omega$
VEA Maximum Output Voltage	$V_{\text{c,max}}$		2.5	–	–	V
VEA Sourcing Current	$I_{\text{src,vea}}$	VEA output current, $V_{\text{c}} = 2.0\text{ V}$	80	100	–	μA
VEA Sinking Current	$I_{\text{snk,vea}}$	VEA output current, $V_{\text{c}} = 1.5\text{ V}$	80	100	–	μA
VEA Clamp Voltage	$V_{\text{c,clamp}}$	$V_{\text{OUT}} < 7.3\text{ V}$	–	1.1	–	V
VC Delay		$V_{\text{OUT}} < 7.3\text{ V}$ with V_{C} pin compensation network disconnected	–	53	60	μs

GATE DRIVER

Sourcing Current	I_{src}	$V_{\text{DRV}} \geq 6\text{ V}$, $V_{\text{DRV}} - V_{\text{GDRV}} = 2\text{ V}$ NCV887600 NCV887601	550 550	800 800	– –	mA
Sinking Current	I_{sink}	$V_{\text{GDRV}} \geq 2\text{ V}$ NCV887600 NCV887601	500 500	600 600	– –	mA
Driving Voltage Dropout (Note 2)	$V_{\text{drv,do}}$	$V_{\text{OUT}} - V_{\text{DRV}}$, $I_{\text{DRV}} = 25\text{ mA}$	–	0.3	0.6	V

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Characteristic	Symbol	Conditions	Min	Typ	Max	Unit
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GATE DRIVER

Driving Voltage Source Current	I_{drv}	$V_{\text{OUT}} - V_{\text{DRV}} = 1\text{ V}$	35	45	–	mA
Backdrive Diode Voltage Drop	$V_{\text{d,bd}}$	$V_{\text{DRV}} - V_{\text{OUT}}$, $I_{\text{d,bd}} = 5\text{ mA}$	–	–	0.7	V
Driving Voltage	V_{DRV}	$I_{\text{VDRV}} = 0.1 - 25\text{ mA}$ NCV887600 NCV887601	5.8 5.8	6.0 6.0	6.2 6.2	V

UVLO

Undervoltage Lock-out, Threshold Voltage	V_{uvlo}	VOUT falling	3.4	3.59	3.8	V
Undervoltage Lock-out, Hysteresis	$V_{\text{uvlo,hys}}$	VOUT rising	300	440	550	mV

THERMAL SHUTDOWN

Thermal Shutdown Threshold (Note 2)	T_{sd}	T_J rising	160	170	180	$^{\circ}\text{C}$
Thermal Shutdown Hysteresis (Note 2)	$T_{\text{sd,hys}}$	T_J falling	10	15	20	$^{\circ}\text{C}$
Thermal Shutdown Delay (Note 2)	$t_{\text{sd,dly}}$	From $T_J > T_{\text{sd}}$ to stop switching	–	–	100	ns

VOLTAGE REGULATION

Voltage Regulation	$V_{\text{OUT,reg}}$	NCV887600 NCV887601	6.66 6.66	6.8 6.8	6.94 6.94	V
Threshold IC Enable		VOUT descending NCV887600 NCV887601	7.1 7.1	7.3 7.3	7.5 7.5	V
Threshold IC Disable		VOUT ascending NCV887600 NCV887601	7.5 7.5	7.7 7.7	7.9 7.9	V
Threshold IC Enable – Voltage Regulation		NCV887600 NCV887601	0.32 0.32	0.5 0.5	– –	V
Threshold IC Disable – Threshold IC Enable		NCV887600 NCV887601	– –	0.4 0.4	– –	V

2. Not tested in production. Limits are guaranteed by design.

TYPICAL CHARACTERISTICS

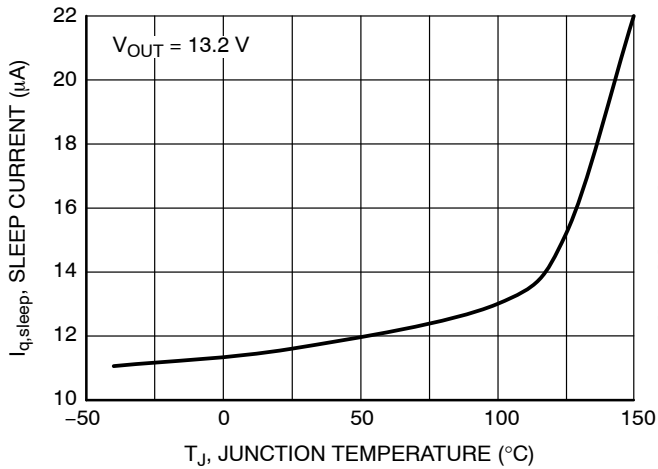


Figure 3. Sleep Current vs. Temperature

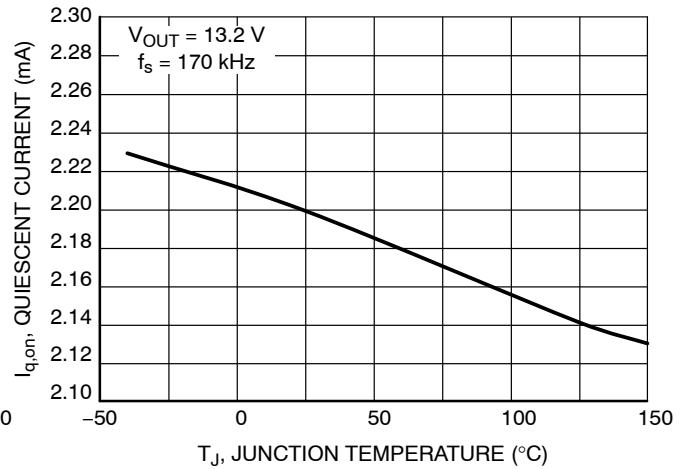


Figure 4. Quiescent Current vs. Temperature

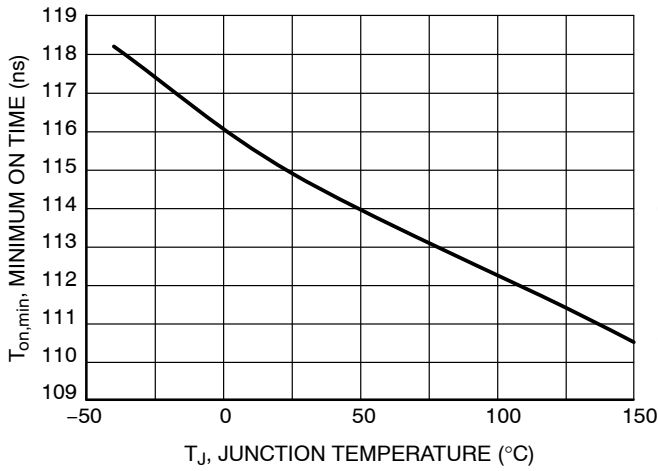


Figure 5. Minimum On Time vs. Temperature

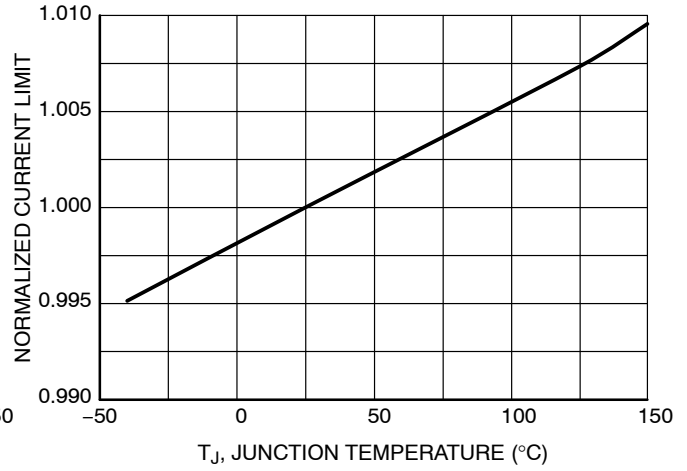


Figure 6. Normalized Current vs. Temperature

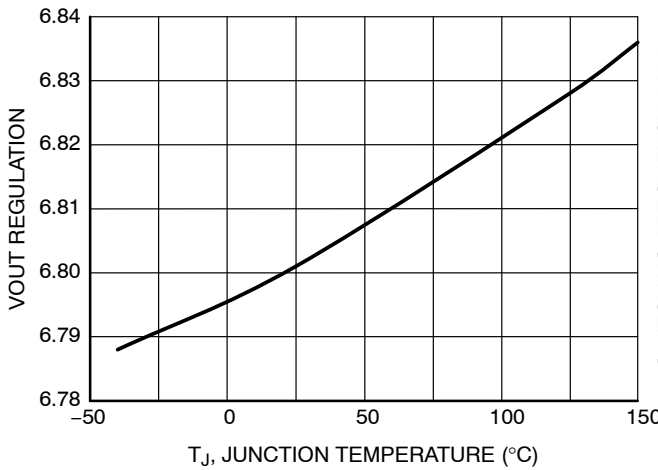


Figure 7. VOUT Regulation vs. Temperature

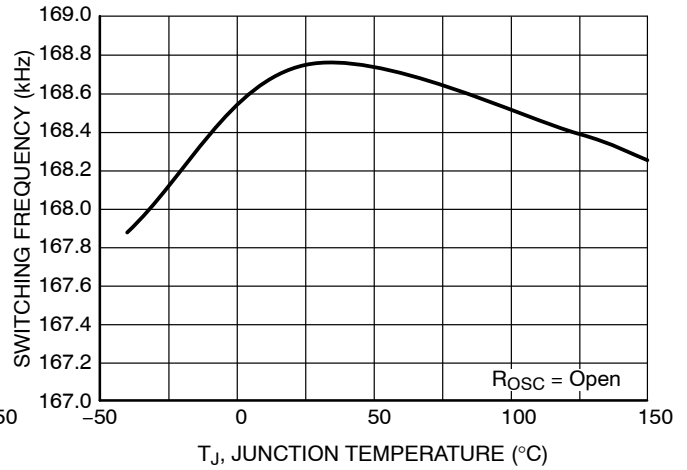


Figure 8. Switching Frequency vs. Temperature

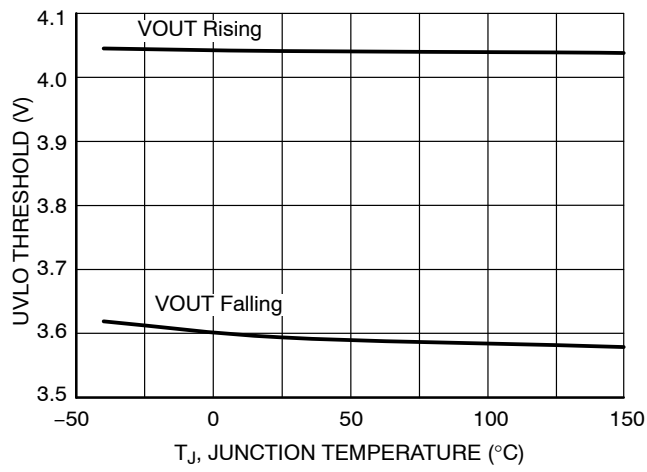


Figure 9. UVLO Threshold vs. Temperature

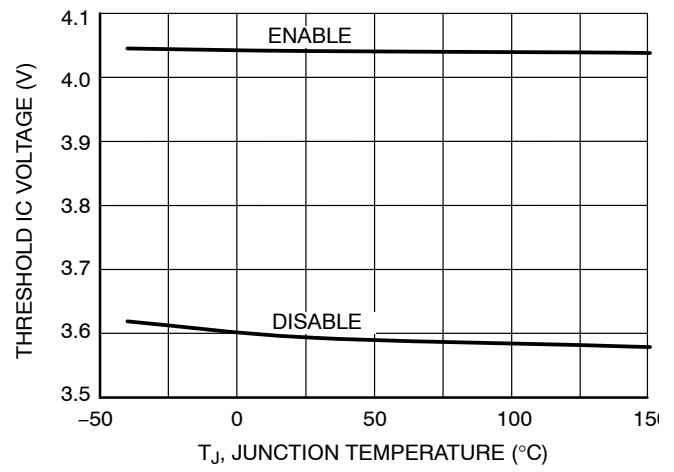


Figure 10. Threshold IC Voltage vs. Temperature

THEORY OF OPERATION

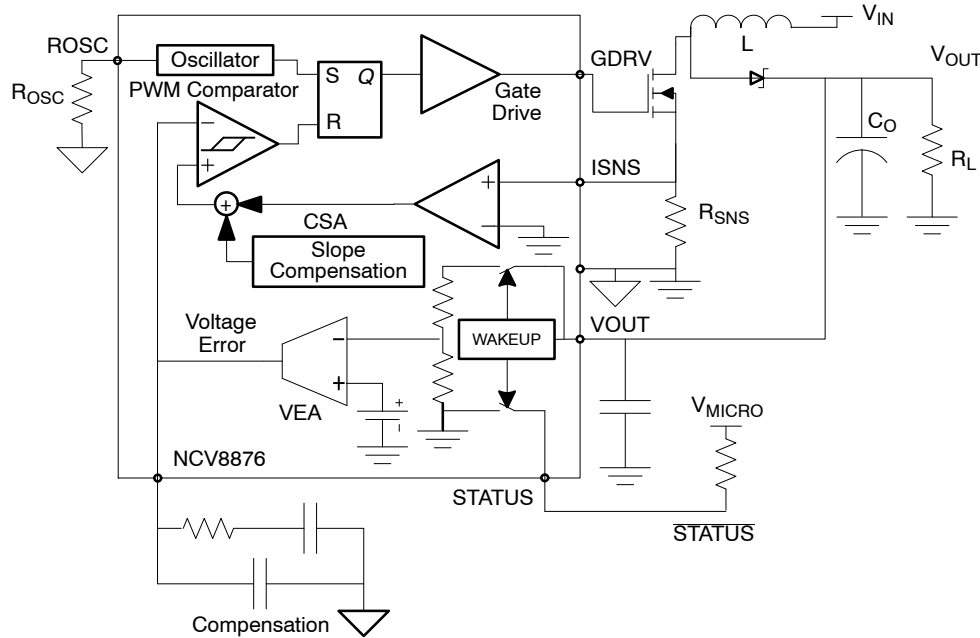


Figure 11. Current Mode Control Schematic

Regulation

The NCV8876 is a non-synchronous boost controller designed to supply a minimum output voltage during Start-Stop vehicle operation battery voltage sags. The NCV8876 is in low quiescent current sleep mode under normal battery operation (12 V) and is enabled when the supply voltage drops below the descending threshold (7.3 V for the NCV887600). Boost operation is initiated when the supply voltage is below the regulation set point (6.8 V for the NCV887600). Once the supply voltage sag condition ends and begins to increase, the NCV8876 boost operation will cease when the supply voltage increases beyond the regulation set point. The NCV8876 low quiescent current sleep mode resumes once the supply voltage increases beyond the ascending voltage threshold (7.7 V for the NCV887600).

The NCV8876 VOUT pin serves the dual purpose: (1) powering the NCV8876 and (2) providing the regulation feedback signal. The feedback network is imbedded within the IC to eliminate the constant current battery drain that would exist with the use of external voltage feedback resistors.

There is no soft-start operating mode. The NCV8876 will instantly respond to a voltage sag so as to maintain normal operation of downstream loads. Once the NCV8876 is enabled, the voltage error operational transconductance amplifier supplies current to set VC to 1.1 V to minimize the feedback loop response time when the battery voltage sag goes below the regulation set point.

Current Mode Control

The NCV8876 incorporates a current mode control scheme, in which the PWM ramp signal is derived from the power switch current. This ramp signal is compared to the

output of the error amplifier to control the on-time of the power switch. The oscillator is used as a fixed-frequency clock to ensure a constant operational frequency. The resulting control scheme features several advantages over conventional voltage mode control. First, derived directly from the inductor, the ramp signal responds immediately to line voltage changes. This eliminates the delay caused by the output filter and the error amplifier, which is commonly found in voltage mode controllers. The second benefit comes from inherent pulse-by-pulse current limiting by merely clamping the peak switching current. Finally, since current mode commands an output current rather than voltage, the filter offers only a single pole to the feedback loop. This allows for a simpler compensation.

The NCV8876 also includes a slope compensation scheme in which a fixed ramp generated by the oscillator is added to the current ramp. A proper slope rate is provided to improve circuit stability without sacrificing the advantages of current mode control.

Current Limit

The NCV8876 features two current limit protections, peak current mode and over current latch off. When the current sense amplifier detects a voltage above the peak current limit between ISNS and GND after the current limit leading edge blanking time, the peak current limit causes the power switch to turn off for the remainder of the cycle. Set the current limit with a resistor from ISNS to GND, with $R = V_{CL} / I_{limit}$.

If the voltage across the current sense resistor exceeds the over current threshold voltage the device enters over current hiccup mode. The device will remain off for the hiccup time of duration $1024/f_{osc}$.

UVLO

Input Undervoltage Lockout (UVLO) is provided to ensure that unexpected behavior does not occur when VIN is too low to support the internal rails and power the controller. The IC will start up when enabled and VIN surpasses the UVLO threshold plus the UVLO hysteresis and will shut down when VIN drops below the UVLO threshold or the part is disabled.

VDRV

An internal regulator provides the drive voltage for the gate driver. Bypass with a ceramic capacitor to ground to ensure fast turn on times. The capacitor should be between 0.1 µF and 1 µF, depending on switching speed and charge requirements of the external MOSFET.

VDRV uses an internal linear regulator to charge the VDRV bypass capacitor. VOUT must be decoupled at the IC by a capacitor that is equal or larger in value than the VDRV decoupling capacitor.

APPLICATION INFORMATION

Design Methodology

This section details an overview of the component selection process for the NCV8876 in continuous conduction mode boost. It is intended to assist with the design process but does not remove all engineering design work. Many of the equations make heavy use of the small ripple approximation. This process entails the following steps:

1. Define Operational Parameters
2. Select Operating Frequency
3. Select Current Sense Resistor
4. Select Output Inductor
5. Select Output Capacitors
6. Select Input Capacitors
7. Select Compensator Components
8. Select MOSFET(s)
9. Select Diode

1. Define Operational Parameters

Before beginning the design, define the operating parameters of the application. These include:

- V_{IN(min)}: minimum input voltage [V]
- V_{IN(max)}: maximum input voltage [V]
- V_{OUT}: output voltage [V]
- I_{OUT(max)}: maximum output current [A]
- I_{CL}: desired typical cycle-by-cycle current limit [A]

From this the ideal minimum and maximum duty cycles can be calculated as follows:

$$D_{\min} = 1 - \frac{V_{\text{IN(max)}}}{V_{\text{OUT}}}$$

$$D_{\max} = 1 - \frac{V_{\text{IN(min)}}}{V_{\text{OUT}}}$$

Both duty cycles will actually be higher due to power loss in the conversion. The exact duty cycles will depend on

conduction and switching losses. If the maximum input voltage is higher than the output voltage, the minimum duty cycle will be negative. This is because a boost converter cannot have an output lower than the input. In situations where the input is higher than the output, the output will follow the input, minus the diode drop of the output diode and the converter will not attempt to switch.

If the calculated D_{max} is higher the D_{max} of the NCV8876, the conversion will not be possible. It is important for a boost converter to have a restricted D_{max}, because while the ideal conversion ratio of a boost converter goes up to infinity as D approaches 1, a real converter's conversion ratio starts to decrease as losses overtake the increased power transfer. If the converter is in this range it will not be able to regulate properly.

If the following equation is not satisfied, the device will skip pulses at high V_{IN}:

$$\frac{D_{\min}}{f_s} \geq t_{\text{on(min)}}$$

Where: f_s: switching frequency [Hz]

t_{on(min)}: minimum on time [s]

2. Select Operating Frequency

The default setting is an open ROsc pin, allowing the oscillator to operate at the default frequency F_s. Adding a resistor to GND increases the switching frequency.

The graph in Figure 12, below, shows the required resistance to program the frequency. From 200 kHz to 500 kHz, the following formula is accurate to within 3% of the expected

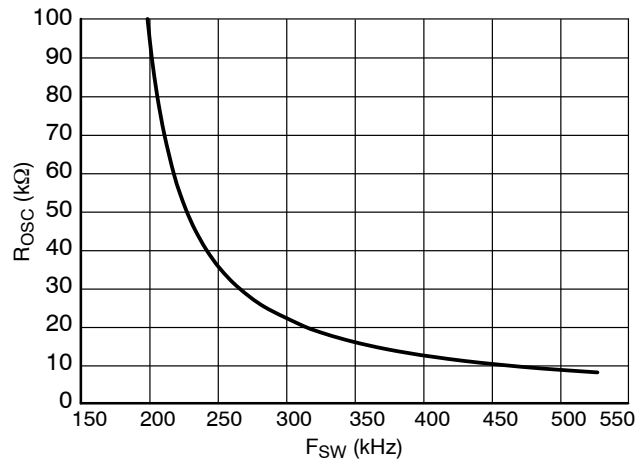


Figure 12. Rosc vs. Fsw

$$R_{\text{OSC}} = \frac{2859}{(F_{\text{sw}} - 170)}$$

Where: f_{sw}: switching frequency [kHz]

R_{OSC}: resistor from ROsc pin to GND [k]

Note: The R_{OSC} resistor ground return to the NCV8876 pin 3 must be independent of power grounds.

3. Select Current Sense Resistor

Current sensing for peak current mode control and current limit relies on the MOSFET current signal, which is measured with a ground referenced amplifier. The easiest method of generating this signal is to use a current sense resistor from the source of the MOSFET to device ground. The sense resistor should be selected as follows:

$$R_S = \frac{V_{CL}}{I_{CL}}$$

Where: R_S : sense resistor [Ω]

V_{CL} : current limit threshold voltage [V]

I_{CL} : desire current limit [A]

4. Select Output Inductor

The output inductor controls the current ripple that occurs over a switching period. A high current ripple will result in excessive power loss and ripple current requirements. A low current ripple will result in a poor control signal and a slow current slew rate in case of load steps. A good starting point for peak to peak ripple is around 20–40% of the inductor current at the maximum load at the worst case V_{IN} , but operation should be verified empirically. The worst case V_{IN} is half of V_{OUT} , or whatever V_{IN} is closest to half of V_{OUT} . After choosing a peak current ripple value, calculate the inductor value as follows:

$$L = \frac{V_{IN(WC)} D_{WC}}{\Delta I_{L,max} f_s}$$

Where: $V_{IN(WC)}$: V_{IN} value as close as possible to half of V_{OUT} [V]

D_{WC} : duty cycle at $V_{IN(WC)}$

$\Delta I_{L,max}$: maximum peak to peak ripple [A]

The maximum average inductor current can be calculated as follows:

$$I_{L,AVG} = \frac{V_{OUT} I_{OUT(max)}}{V_{IN(min)} \eta}$$

The Peak Inductor current can be calculated as follows:

$$I_{L,peak} = I_{L,avg} + \frac{\Delta I_{L,max}}{2}$$

Where: $I_{L,peak}$: Peak inductor current value [A]

5. Select Output Capacitors

The output capacitors smooth the output voltage and reduce the overshoot and undershoot associated with line transients. The steady state output ripple associated with the output capacitors can be calculated as follows:

$$V_{OUT(ripple)} = \frac{I_{OUT(max)} (V_{OUT} - V_{IN(min)})}{(C_{OUT} f)^2} + \frac{I_{OUT(max)} V_{OUT} R_{ESR}}{V_{IN(min)}}$$

The capacitors need to survive an RMS ripple current as follows:

$$I_{Cout(RMS)} = I_{OUT} \sqrt{\frac{V_{OUT} - V_{IN(min)}}{V_{IN(min)}}}$$

The use of parallel ceramic bypass capacitors is strongly encouraged to help with the transient response.

6. Select Input Capacitors

The input capacitor reduces voltage ripple on the input to the module associated with the ac component of the input current.

$$I_{Cin(RMS)} = \frac{V_{IN(WC)}^2 D_{WC}}{L_f V_{OUT} 2 \sqrt{3}}$$

7. Select Compensator Components

Current Mode control method employed by the NCV8876 allows the use of a simple, Type II compensation to optimize the dynamic response according to system requirements.

8. Select MOSFET(s)

In order to ensure the gate drive voltage does not drop out the MOSFET(s) chosen must not violate the following inequality:

$$Q_{g(total)} \leq \frac{I_{drv}}{f_s}$$

Where: $Q_{g(total)}$: Total Gate Charge of MOSFET(s) [C]

I_{drv} : Drive voltage current [A]

f_s : Switching Frequency [Hz]

The maximum RMS Current can be calculated as follows:

$$I_{D(max)} = I_{out} \sqrt{\frac{D}{1-D}}$$

The maximum voltage across the MOSFET will be the maximum output voltage, which is the higher of the maximum input voltage and the regulated output voltage:

$$V_{Q(max)} = V_{OUT(max)}$$

NVMFS5844NL 12 m Ω , 60 V SO-8FL package MOSFET is a recommended device.

9. Select Diode

The output diode rectifies the output current. The average current through diode will be equal to the output current:

$$I_{D(avg)} = I_{OUT(max)}$$

Additionally, the diode must block voltage equal to the higher of the output voltage and the maximum input voltage:

$$V_{D(max)} = V_{OUT(max)}$$

The maximum power dissipation in the diode can be calculated as follows:

$$P_D = V_{f(max)} I_{OUT(max)}$$

Where: P_d : Power dissipation in the diode [W]

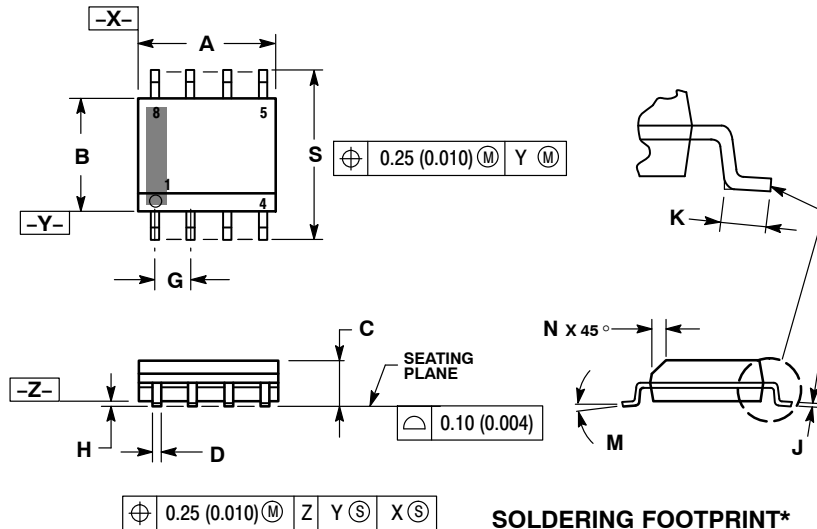
$V_{f(max)}$: Maximum forward voltage of the diode [V]

The 4 amp, 40 V NRVB440MFS SO-8FL package Schottky diode is a recommended device.

10. Design Notes

- VOUT serves a dual purpose (feedback and IC power).
The VDRV circuit has a current pulse power draw resulting in current flow from the output sense location to the IC. Trace ESL will cause voltage ripple to develop at IC pin VOUT which could affect performance.
 - ◆ Use a 1 μ F IC VOUT pin decoupling capacitor close to IC in addition to the VDRV decoupling capacitor.
- Classic feedback loop measurements are not possible (VOUT pin serves a dual purpose as a feedback path and IC power). Feedback loop computer modeling recommended.
 - ◆ A step load test for stability verification is recommended.
- Compensation ground must be dedicated and connected directly to IC ground.
 - ◆ Do not use vias. Use a dedicated ground trace.
- ROSC programming resistor ground must be dedicated and connected directly to IC ground
 - ◆ Do not use vias. Use a dedicated ground trace.
- IC ground & current sense resistor ground sense point must be located on the same side of PCB.
 - ◆ Vias introduce sufficient ESR/ESL voltage drop which can degrade the accuracy of the current feedback signal amplitude (signal bounce) and should be avoided.
- Star ground should be located at IC ground pad.
 - ◆ This is the location for connecting the compensation and current sense grounds.
- The IC architecture has a leading edge ISNS blanking circuit. In some instances, current pulse leading edge current spike RC filter may be required.
 - ◆ If required, 120 pF + 750 Ω are a recommended evaluation starting point.

PACKAGE DIMENSIONS

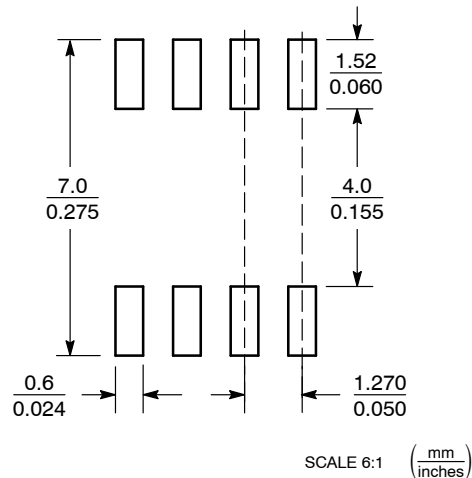
SOIC-8 NB
CASE 751-07
ISSUE AK

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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